Thermal Reshaping of Gold Microplates: Three Possible Routes and Their Transformation Mechanisms

Rui Wang† and Dmitry Kurouski‡∗,†

†Department of Biochemistry and Biophysics and ‡The Institute for Quantum Science and Engineering, Texas A&M University, College Station, Texas 77843, United States

Supporting Information

ABSTRACT: The thermal stability of Au micro/nanomaterials (AuMNLs) has always been a hot topic because their physicochemical properties, like surface plasmon resonance and catalytic activity, are closely related to their morphology or exposed crystal planes which are heat-sensitive. In this study, we made careful and systematic investigation of thermal deformation and reshaping of individual Au microplates (AuMPs) using atomic force microscopy. We found that AuMPs could transform into walled AuMPs (WAuMPs) and concave AuMPs (CAuMPs) at just 300 °C, which are thermodynamically and kinetically favorable products, respectively. A small fraction of AuMPs, named invariable AuMPs (IAuMPs), remained intact. However, both CAuMPs and IAuMPs can be converted to WAuMPs if the temperature is further increased. We also showed that melting of AuMPs begins from vertices and the boundaries between the top and side plane, rather than only side crystal planes as envisaged before. Finally, we performed a series of electrochemical studies showing that WAuMPs exhibited substantially higher electrocatalytic conversion of methanol at lower formal potential compared to intact AuMPs. This work shows that thermal reshaping of Au is far more complicated as was expected before. It also demonstrates how thermal reshaping can be used to improve electrocatalytic performance of Au and potentially other MNLs.

KEYWORDS: Au microplates, thermal stability, reshaping mechanism, electrochemical catalysis, AFM

INTRODUCTION

Au micro/nanomaterials (AuMNLs) have attracted extensive attention because of their potential applications in different fields, including bioimaging,1–3 drug delivery,4–6 data storage,7 and catalysis.8–10 With certain crystal facets exposed or anisotropic morphology formed, they exhibit many unique physicochemical properties, such as surface plasmon resonance (SPR)11–14 and facet-dependent catalysis.15–17 However, SPR generates a large amount of heat, and many catalytic reactions occur at high temperatures, both of which cause deformation and reshaping of AuMNL, thereby losing activity.18–22 Therefore, understanding the thermal stability and reshaping mechanism of AuMNLs is highly important. Until now, many efforts have been devoted to investigating the thermal reshaping behavior of Au nanomaterials.23–26 It was observed that the melting point of Au nanoparticles (Au NPs) is strongly associated with their size. For example, the melting temperature of 5 nm Au NPs drops sharply from 1100 to 600 K when their sizes decrease to 2 nm.27 Moreover, the AuMNLs prone to sintering after melting follow two mechanisms: (1) Ostwald ripening, which involves small crystals or clusters dissolving and redepositing onto larger crystals; (2) particle migration and coalescence involving spontaneous Brownian motion and fusion of particles.28–30

Au micromaterials are generally considered to have higher thermal stability than Au nanomaterials because of their larger size and smaller surface free energy.31–33 However, recent studies have shown that some Au micromaterials, such as Au microplates (AuMPs), also undergo deformation and reshaping at temperatures much below the melting point of bulk Au (1337 K).34 Kan et al.35 found the fragmentation behavior of AuMPs when the heating temperature is above 450 °C, which can be attributed to the fact that the melting point of the side facets (110) is lower than that of the top facets (111). Independently, Kulkarni and Radha36 found that AuMPs could build up high edges upon heating. The researchers proposed that such reshaping could be caused by migration of Au atoms from the center outwards to the edges of AuMPs. These findings show that heat-induced transformations in Au micromaterials are very sophisticated. Also, it becomes evident that there is no clear understanding about possible reshaping routes of AuMPs, the relating factors and transformation mechanism of AuMPs.

In this study, we made careful and systematic investigation of the thermal deformation and reshaping of AuMPs. We used atomic force microscopy (AFM) to monitor transformations in individual AuMPs heated at 300, 400, and 500 °C. We found that AuMPs could be transformed into walled AuMPs.
(WAuMPs) and Concave AuMPs (CAuMPs) (Scheme 1), the thermodynamic and kinetic products of AuMPs reshaping, respectively. With prolonged heating, the WAuMPs were gradually deformed and fragmented, which is similar to the observation made by Kan and co-workers.35 Some of the AuMPs remained intact (invariable AuMPs [IAuMPs]) upon heating. Nevertheless, CAuMPs and IAuMPs could be converted to WAuMPs at elevated temperatures (Scheme 1). The appearance of WAuMPs is similar with Kulkarni’s finding,36 however, by using the magnitude-mode AFM and high-resolution AFM (HRAFM), we found that WAuMPs were formed by shrinking from the edge to the interior, rather than as Kulkarni speculated. The HRAFM also showed that the walls of the WAuMPs are made of many ultrathin (~2 nm) layered structures. One explanation for these phenomena is that the melting of AuMPs actually begins at the vertices and the boundaries between the top and side plane, rather than only the side crystal plane as envisaged before. Finally, we found that WAuMPs exhibited much higher electrocatalytic activity (119.7 μA cm⁻²) than that of intact AuMPs (67.1 μA cm⁻²) in the methanol oxidation reaction, which can be attributed to their unique nanosized layered structures on the walls.

■ RESULTS AND DISCUSSION

Three Possible Thermal Transformation Routes of AuMPs and Their Affecting Factors. The AuMPs were synthesized according to a “wet-chemical” protocol.37 The as-made AuMPs were generally hexagonal and triangular microplates with 15–35 μm in length. Two groups of AuMPs with different thickness: 30 ± 10 nm (30 nm group) and 60 ± 20 nm (60 nm group) were synthesized by controlling the adding amount of the polyvinyl pyrrolidone (PVP), a surfactant which can reduce the growth rate of basal planes, but enhance those of lateral planes. After drop casting on precleaned Si wafer, AFM images of a specific piece of AuMP were taken both before and after calcination. Figure 1a–d shows a representative WAuMP growth results: the selected 30 nm group AuMP started the “wall building” process which showed a higher edge than the interior after 400 °C calcination. As the calcination time increased from 30 to 120 min, the wall height increased from 23 to 40 nm. Meanwhile, after calcination for 30 and 120 min, the average length of the AuMP was also shortened by 1.3 and 2.4 μm, respectively, compared with that of the corresponding as-made AuMP. In contrast, the thickness of the interior of the AuMP changed little during the whole process, indicating that the deformation and reshaping only starts from the edge of the WAuMPs. The beginning of CAuMP growth is quite similar: the walls were generated and the AuMP experienced a slight shrink (~0.5 μm) after 30 min of heating (Figure 1e–h), creating a concave structure with a 2–4 nm thick hole in the

![Figure 1](image.png)

Figure 1. Representative AFM images of WAuMPs (b,c), CAuMPs (f,g), and IAuMPs (j,k) formed by the 30 nm group calcinated at 400 °C for different times and their corresponding as-made AuMPs (a,e,i), respectively. (d,h,l) are the corresponding height profile along the red dashed line in (a–c), (e–g), and (i–k), respectively.
center. However, instead of building up the wall and shrinking further as WAuMPs do, the hole was re-filled and the resulting CAuMPs had similar appearance with the as-made ones. Because of their opposite growth performance, products with a “wall” height less than 5 nm and width wider than 5 μm are defined as CAuMPs, and the converse would be WAuMPs. Besides WAuMPs and CAuMPs, we found the rest AuMPs with both thickness and length maintained after 400 °C calcination for the 30 nm group, denoted as IAuMPs. One can expect that these IAuMPs have higher transformation threshold than those of WAuMPs and CAuMPs. This hypothesis will be verified in the experiment that will be discussed below. For the 60 nm group, we also found the same reshaping pathways, that is, WAuMPs, CAuMPs, and IAuMPs, after 400 °C calcination (Figure S1), except that the formation of CAuMPs was slower (Figure S2) than that of the 30 nm group.

To further understand the factors affecting the deformation and reshaping routes of AuMPs, the thermal stability tests for both 30 and 60 nm groups were conducted at different temperature (300, 400, and 500 °C). For each group calcinated at a certain temperature, 25 pieces of AuMPs were unbiasedly chosen and traced by AFM imaging. As shown in Figures S3–S5, Tables 1 and 2, we can see that a part of the products.

Table 1. The Percentage of Different Thermal Products of the 30 nm Group after Calcination at Different Temperatures for 2 h

<table>
<thead>
<tr>
<th>Temperature (°C)</th>
<th>WAuMPs (%)</th>
<th>CAuMPs (%)</th>
<th>IAuMPs (%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>300</td>
<td>52</td>
<td>4</td>
<td>44</td>
</tr>
<tr>
<td>400</td>
<td>68</td>
<td>8</td>
<td>24</td>
</tr>
<tr>
<td>500</td>
<td>96</td>
<td>4</td>
<td>0</td>
</tr>
</tbody>
</table>

*Extracted from Figures S3, S6, S7.

Table 2. The Percentage of Different Thermal Products of the 60 nm Group after Calcination at Different Temperatures for 2 h

<table>
<thead>
<tr>
<th>Temperature (°C)</th>
<th>WAuMPs (%)</th>
<th>CAuMPs (%)</th>
<th>IAuMPs (%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>300</td>
<td>0</td>
<td>0</td>
<td>100</td>
</tr>
<tr>
<td>400</td>
<td>40</td>
<td>12</td>
<td>48</td>
</tr>
<tr>
<td>500</td>
<td>92</td>
<td>0</td>
<td>8</td>
</tr>
</tbody>
</table>

*Extracted from Figure S3, S6, S7.

30 nm group AuMPs have grown 2–5 nm walls after 300 °C calcination, which is a clear sign of WAuMPs reshaping, while 60 nm group AuMPs were still intact even after 120 min. When the calcination temperature was brought up to 400 °C, the ratio of WAuMPs in the 60 nm group (10 out of 25) increased, but still much less than that of the 30 nm group (17 out of 25) (Figures 1, S1, S6 and Tables 1 and 2); and after 500 °C heating, most of them were transformed to WAuMPs or CAuMPs (Figures S7–S9, Tables 1 and 2). Based on the above findings, it can be expected that the thermal stability of the 60 nm group is higher than that of the 30 nm group, that is, thicker AuMPs lead to higher thermal stability.

**Further Conversion among Different Reshaping Products.** Next, we studied the conversion possibility among these three reshaping products. With prolonged heating at a certain temperature (400 °C), CAuMPs would fill the holes and become IAuMPs (Figure 2a–d, f–i). Surprisingly, their edges became higher with further temperature increase to 500 °C and they either turned into WAuMPs (Figure 2a–e) or started a new round of CAuMPs growth (Figure 2f–j). Similarly, IAuMPs could also be converted to WAuMPs at higher temperatures (Figure 2k–o). These results indicate that CAuMPs and IAuMPs are more unstable and can be converted to WAuMPs at higher temperatures, which is consistent with our hypothesis: WAuMPs and CAuMPs are thermodynamically and kinetically controlled products, respectively, and IAuMPs are species with higher transformation threshold. Besides the conversion of CAuMPs and IAuMPs, we also observed that after prolonged heating, some of these WAuMPs could be disintegrated into mesh structures (Figure S10a–j).

**Nanostructures on the WAuMPs.** In order to unravel the nature of the walls in WAuMPs, we applied magnitude-mode AFM to measure them. Compared to the previously used height mode AFM, magnitude-mode AFM is more sensitive to changes in the hardness of the sample, such as from the silicon substrate to the gold sample surface. As shown in Figure 3, we can see the obvious shrinkage residues of WAuMPs on both low magnification (Figure 3b) and zoomed-in magnitude-mode AFM (Figure 3d), and the shrink of the vertices are even more pronounced than the edges. However, these phenomena were not seen on the corresponding height mode AFM (Figure 3a,c). Furthermore, we studied the evolution of the wall as the heating time changes using HRAFM (Figure 4). The edge and interior of AuMPs did not show significant differences before heating (0 min, Figure 4a–d). After heating at 500 °C for 30 min (Figure 4e–h), the edges turned into layered structures with ~1 nm thickness, but the interior was still flat. As the heating time increases, the layered structure gradually thickened to ~1.5 nm (2 h, Figure 4i–l) and ~3 nm (6 h, Figure 4m–p), while the middle remained stable. Combined with the fact that the edges of AuMPs shrunked, we can infer that the gold atoms at the edges would become unstable during heating and migrate inward, followed by gradually cooling to form layered structures. This is particularly significant at the vertices, which may relate to their lower coordination number and higher surface energy and therefore more thermally unstable.

Another interesting finding is that the surface of these AuMPs, both edge and interior, are covered with small NPs, which were not found either by scanning electron microscopy (SEM) (Figures S12, S13) or high-resolution transmission electron microscopy (TEM) (Figure S14) imaging. This suggests that they have organic rather than metallic nature. Further analysis of these NPs revealed that the particle size was 1–2 nm before calcination (Figure 4d), and increased to ~3 nm (Figure 4h) after calcination at 500 °C, and did not grow further with continuous calcination (Figure 4i,p). In order to exclude the image artifacts brought by the AFM probes, two brand new AFM probes with different tip types (standard T type and pyramid-like tip) were used for HRAFM imaging of the same area. As shown in Figure S15, the two HRAFM images are identical, and the measured particle sizes are also very close, indicating these NPs are real, instead of artifacts. Moreover, we found that when these WAuMPs were stored for...
1 year, the surface NPs would continue to grow to 10−20 nm (Figure S16a,b). After washing with a piranha solution, these NPs disappeared and the surface of WAuMPs became flat (Figure S16c,d), indicating that these NPs are highly likely to be surfactant residues, which are prone to aggregate slowly. To confirm the nature of these small NPs, we conducted the energy dispersion spectrum analysis (Figure S17) on both as-made AuMPs and WAuMPs (formed after 500 °C calcination for 2 h). On both samples, we found the existence of C, O, and Br which can be assigned to PVP and hexadecyltrimethylammonium bromide (CTAB) used during the synthesis along with the Au. The atomic elementary ratio (C/O/Br/Au) was reduced from 4.0:0.5:0.5:1 to 1.7:0.2:0.3:1, indicating that the calcination is not capable to remove the organic species entirely, which can thereafter construct the NPs.

**Formation Mechanisms of the Thermal Transformation of AuMPs.** In the study of the thermal stability of AuMNLs, it is usually found that the melting phenomenon occurs only at the {110} crystal facets, while the {111} facets remain crystallized until and even higher than the melting point.²⁶,³⁸ For instance, surface melting starts at ∼500 °C for {111} oriented gold structures, as reported before. Kan et al.³⁵ discovered that the deformation and cracking of the AuMPs begins with the edges that can be assigned to Au {110} facets. However, based on our above results, the deformation and reshaping process of AuMPs is much more complicated. Based on our results, we hypothesize that thermal reshaping of {110} facets first begins from Au atoms located in vertices and boundaries (between the side and top facets). Possessing high kinetic energy, these Au atoms move inward (Scheme 2a).³⁹ After the top atoms on the surface have migrated, the atoms beneath them (still belong to {110} facets) become new vertices and boundaries. We hypothesize that WAuMPs and CAuMPs undergo different evolutionary processes after this step. WAuMPs appear as a result of the thermodynamically controlled growth. Specifically, the external energy is much lower than the reaction energy, which helps in the formation of the triangular shape. On the other hand, CAuMPs undergo a different process where the high energy of the boundary helps in the formation of the triangular shape and the removal of the organic species. This process helps in the formation of the CAuMPs, which are much more stable than the WAuMPs.
higher than both activation energy $E_a$ and $E_b$ (Scheme 2b) and the atom migration proceeds faster, leading to rapid “wall” generation (Step IIa and Step IIIa). At the same time, in the case of CAuMPs, which appear as a result of kinetically controlled growth, the external energy can only overcome $E_a$ (Scheme 2b). Therefore, besides the new vertex and boundary atoms, the newly generated wall atoms will be activated again and migrate further inward slowly (Step IIb). This will first result in the formation of a hole. Next, this hole will be filled up gradually to reach a new stable structure (Step IIIb). When the temperature is elevated, CAuMPs can also further convert to WAuMPs (Figure 2a−e) when the energy is enough for it to pass $E_b$ (Scheme 2b). These principles also apply to IAuMPs, which have higher transformation thresholds (Figure 2k−o). It should be noted that the transformation threshold temperature appears to be an intrinsic property of AuMPs and has little to do with their shape. In order to prove that the WAuMPs formation is only a manner of "surface melting", rather than gravity affected "direct melting", we calcinated the AuMPs with a substrate slant by 45°. The formation of WAuMPs was still found, and the width of the sides of the wall was not correlated with the substrate tilt direction (Figure S18), which proved that the formation was independent of gravity. Furthermore, we confirmed the AuMPs with 5−15 μm in length can also be transformed to WAuMPs upon heating at 500 °C for 2 h (Figure S19), indicating that the WAuMPs transformation can also be applied to smaller AuMPs. Moreover, in order to study the relevance between the WAuMPs and their plasmonic property, we measured the absorption spectra (Figure S20) of the 30 nm group AuMPs before and after calcination at 300, 400, and 500 °C for 2 h, respectively. For the as-made and 300 °C calcined AuMPs, we can clearly observe an absorption peak located at $\sim$1100 nm, which corresponds to the in-plane dipole resonance mode of the AuMPs. However, this peak disappeared after 400 and 500 °C calcination, which corresponds to the massive formation of WAuMPs (yield 68 and 96%, respectively, Table 1). In other words, the WAuMPs are not as plasmonic active as their as-made counterparts. We
hypothesized that the “wall” formation actually is a kind of distortion process to the vertices and edges, where the plasmonic property comes from. Until now, we have only confirmed that their thickness is a vital parameter for the generation of WAuMPs, which may affect the transformation threshold temperature. At the same time, it is still impossible to predict the type of reshaping of a particular AuMP prior to calcination. We hypothesize that this may only be related to the local properties of AuMPs, that is, unstable vertices and boundaries because the deformation and reshaping we observed are confined to edges and far below the melting point.

Electrocatalysis Study of WAuMPs. Previously, it has been reported that AuMNLs exhibit strong electrochemical catalytic activity. The question to ask is whether thermally reshaped WAuMPs would have different electrocatalytic activities compared to the intact AuMPs. To answer this question, we investigated electrocatalytic properties of WAuMPs (formed at 500 °C) for the electrocatalytic oxidation of methanol. WAuMPs were deposited on the top of a commercial glassy carbon electrode. The same electrode deposited with intact AuMPs was used as a reference. However, one could note that intact AuMPs may have a surfactant present on their surface. To avoid the contribution of surfactant-masked areas of AuMPs, we prepared surfactant-free AuMPs by treating intact AuMPs in a UV ozonator.

Moreover, a standard Au electrode (poly-gold) was mechanically cleaved followed by activation to serve as a reference, too. Cyclic voltammograms (CV) were obtained for all electrodes in 0.1 M KOH (Figure S21). An oxidation wave located at 0.32 V and a reduction peak at ~0.16 V were observed, which can be assigned to the formation of surface oxides and their reduction process, respectively. The surface area of WAuMPs, surfactant-free AuMPs, and as-made AuMPs-modified glassy carbon electrodes was calculated to be 0.015, 0.029, and 0.011 cm², respectively, from the charge consumed when reducing surface oxides on clean Au electrodes using the reported value of 400 μC cm⁻² (see Methods). We have found that anodic waves became broader and larger for all of the electrodes upon addition of 1 M methanol to the electrolyte, indicating oxidation of methanol (Figure 5a). We found that the peak current density of WAuMP electrodes (119.7 μA cm⁻²) was significantly higher than that of intact AuMP (67.1 μA cm⁻²), surfactant-free AuMP (82.3 μA cm⁻²), and poly-gold (61.2 μA cm⁻²) electrodes (Figure 5b). This indicates that WAuMPs have significantly higher electrocatalytic activity toward methanol oxidation comparing to intact and surfactant-free AuMPs. Moreover, the formal potential of the oxidation peak of WAuMPs (0.265 V) was also much lower than the rest of the samples (~0.33 V), indicating that WAuMPs are capable to oxidize methanol at much lower formal potential than intact, surfactant-free AuMPs and poly-gold. One can envision that such enhancement in the electrocatalytic activity of WAuMPs can be explained by the unique “wall” architecture of these nanostructures. Additional studies are required to fully understand the structure–catalytic activity relationship of WAuMPs.

CONCLUSIONS

In conclusion, we investigated three possible thermal reshaping routes of AuMPs. Two of them lead to a formation of WAuMPs and CAuMPs which are the products of thermodynamic and kinetic transformations of AuMPs, respectively. The third route does not produce morphologically different structures suggesting that IAuMPs have higher transformation threshold. This hypothesis is supported by the observation that at higher temperatures CAuMPs and IAuMPs can be converted into WAuMPs. We also found that a yield of WAuMPs was determined by the thickness of AuMPs and the heating temperature. We also showed that WAuMPs were formed by migration of Au atoms inwards from the edges to the center of the plate. Based on the above facts, we proposed a new model of thermal reshaping of AuMPs. According to this model, Au atoms located in boundaries of AuMPs are activated first. Their high kinetic energies slowly decrease as they move inwards. This energy-driven migration of atoms results in the appearance of walls at the edges of AuMPs. We also showed that these unique architectures exhibit much higher electrocatalytic methanol oxidation activities compared to intact AuMPs.

METHODS

Chemicals. Diethylene glycol (DEG, 99%), polyvinylpyrrolidone (PVP, average molecular weight 40 000), hexadecyltrimethylammonium bromide (CTAB, 98%), gold (III) chloride trihydrate (HAuCl₄·3H₂O, 99.9%), potassium hydroxide (KOH, 86%), and Nafion 117 solution (~5%) were bought from Sigma-Aldrich (St. Louis, MO). Ethanol was obtained from Decon Labs (King of Prussia, PA). Anhydrous methanol (CH₃OH), hydrogen peroxide (H₂O₂, ~30%), and sulfuric acid (H₂SO₄) were bought from Avantor (Center Valley, PA). No further purification was conducted for all chemicals.

AuMPs Synthesis. A typical synthesis of AuMPs with a thickness of 30 ± 10 nm was carried out as follows. 112 mg of CTAB and 512 mg of PVP were dissolved in 7.2 mL of DEG at 150 °C and maintained for 45 min. The solution changed from dark yellow, colorless to brown and changed to golden color finally. After that, the above solution was cooled down to

Figure 5. CVs (a) and calculated current density (b) for methanol oxidation at WAuMPs, surfactant-free, as-made and poly-gold electrodes. Scan rates are 10 mV s⁻¹.
allow the precipitation of the AuMPs, centrifugation (8000 rpm, 3 min) and washing with ethanol was carried out to collect them. The as-made AuMPs were dispersed in ethanol (10 mL) finally. The preparation of the AuMPs with 60 ± 20 nm thickness was proceeded in a similar way with 256 mg PVP added, instead of 512 mg.

Calcination of AuMPs. The as-made AuMPs were deposited on clean Si wafer, followed by sonication for 5 s to remove stacked AuMPs and superfluous surfactant. For each group, 25 pieces of AuMPs were chosen unbiased and marked under optical microscopy of AFM. AFM images of them were taken before and after calcination at a certain temperature. The heating rate for all of the samples is 5°C/min.

Electrochemical Catalysis Study. For the preparation of WAuMPs, surfactant-free AuMPs and as-made AuMPs-modified glassy carbon electrodes, the WAuMPs, surfactant-free AuMPs, and as-made AuMPs were dispersed in ethanol with a concentration of 2 mg mL⁻¹. Commercial glassy carbon electrodes were polished by using 0.3 μm alumina slurries followed by 0.05 μm ones, subsequently cleaned by water. The glassy carbon electrodes were modified by drop casting of the Au ethanolic solution (10 μL) and dried naturally. Later, 2 μL of Nafion solution (5 wt %) was drop casted on the electrodes and dried naturally. For each electrode, the CV in 0.1 M KOH was measured, and its surface area could be calculated from the following equation:

\[
S = \frac{A}{r \times k}
\]

where S is the calculated surface area; A is the consumed charge of the Au oxide reduction in 0.1 M KOH, which can be estimated by the integrated area of the reduction wave (Figure S21); r is the scan rate, which is 10 mV s⁻¹ throughout our experiment; k represents consumed charge for a clean Au electrode, which reported to be 400 μC cm⁻².

Characterization. Low- and HRAFM were done on a CombiScope-1000SPM and SPM SmartSPM-1000 system (AIST-NT-HORIBA), respectively. Unless mentioned in the text, the AFM images taken in our work are low-resolution AFM images. The resolution for low- and HRAFM images are 60–120 and 3–20 nm/ pixel, respectively. TEM, selected area electron diffraction, and high-resolution TEM (HRTEM) were carried out by using an FEI electron microscope (Tecnai G2 F20 ST, 200 kV). SEM imaging was performed by using a JEOL scanning electron microscope (JSM-7500F, 5 kV). The absorption spectra were taken on a Hitachi UV–Vis–NIR spectrophotometer (U-4100). Electrochemical measurements were conducted on a CHI electrochemical workstation (CHI 700e) with a three-electrode cell. A glassy carbon electrode (4 mm in diameter), a platinum electrode, and a Ag/AgCl electrode (3 M NaCl) were used as the working, auxiliary, and reference electrode, respectively. UV-ozone treatment (1 h) was performed by using a commercial UV–ozone cleaner (Ossila) to obtain surfactant-free AuMPs.

**ASSOCIATED CONTENT**

3 Supporting Information

The Supporting Information is available free of charge on the ACS Publications website at DOI: 10.1021/acsami.9b15600.

AFM images of reshaping at 300, 400, and 500°C; SEM images; optical images; HRTEM images; CV in the absence of methanol (PDF)

**AUTHOR INFORMATION**

*Corresponding Author*

E-mail: dkurouski@tamu.edu.

**ORCID**

Rui Wang: 0000-0002-9452-9241

Dmitry Kurouski: 0000-0002-6040-4213

**Notes**

The authors declare no competing financial interest.

**ACKNOWLEDGMENTS**

The work was supported by the startup funds from Texas A&M University. We also acknowledge the TAMU Materials Characterization Facility for SEM operation. Dr. Hansoo Kim from the Microscopy and Imaging Center of TAMU is acknowledged.

**REFERENCES**


14. Yang, J.; Zhang, F.; Chen, Y.; Qian, S.; Hu, P.; Li, W.; Deng, Y.; Fang, Y.; Han, L.; Luqman, M.; Zhao, D. Core-shell Ag@SiO2 2@


